Client Code: SDIYPL.425AUS

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1. Name of conveying party(ies): (List using letters or numbers for multiple parties) 1. Byung-Il Song 2. Han-Seok Yun 3. Tetsuya Okada 4. Jong-Woon Yang 5. Eui-Jeong Hwang Additional name(s) of conveying party(ies) attached? () Yes (X) No 3. Nature of conveyance: (x) Assignment () Security Agreement () Merger () Change of Name	2. Name and address of receiving party(ies): Name: Samsung SDI, Co., Ltd. Street Address: 428-5, Gongse-dong, Giheung-gu City: Yongin-si, Gyeonggi-do Country: Korea Additional name(s) of receiving party(ies) attached? () Yes (X) No	
() Other: Execution Date: (List as in section 1 if multiple signatures) 1-5 February 7, 2012	 4. US or PCT Application number(s) or US Patent number(s): (X) Patent Application No.: 13/422,970 Filing Date: March 16, 2012 Additional numbers attached? () Yes (X) No 	
Party to whom correspondence concerning document should be mailed: Customer No. 20,995	Total number of applications and patents involved: 1	
Address: Knobbe, Martens, Olson & Bear, LLP 2040 Main Street, 14th Floor Irvine, CA 92614 Return Fax: (949) 760-9502 Attorney's Docket No.: SDIYPL.425AUS		
7. Total fee (37 CFR 1.21(h)): \$40	8. Deposit account number: 11-1410	
(X) Authorized to be charged to deposit account	Please charge this account for any additional fees which may be required, or credit any overpayment to this account.	
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Client Code: SDIYPL.425AUS

Page 1

ASSIGNMENT

WHEREAS, WE, the undersigned, have invented certain new and useful improvements in a **BATTERY SYSTEM**, the specification of which was executed on even date herewith.

AND WHEREAS, Samsung SDI Co., Ltd., (hereinafter "ASSIGNEE"), with its principal place of business at 428-5. Gongse-dong, Giheung-gu, Yongin-si, Gyeonggi-do, Republic of Korea, desires to acquire the entire right, title, and interest in and to the said improvements with respect to the United States of America, its territories and possessions.

NOW, THEREFORE, in light of good and valuable consideration, the receipt of which is hereby acknowledged. I, the said inventor, do hereby acknowledge that I have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title, and interest throughout the world in, to and under the said improvements, and the said application and all provisional applications relating thereto, and all divisions, renewals and continuations thereof, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof, and all rights of priority under International Conventions and applications for Letters Patent which may hereafter be filed for said improvements in any country or countries foreign to the United States, and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and I hereby authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said improvements to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I HEREBY covenant and agree that I will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

Date:	2012/2/7	Signature: Name: Byung-II Song Address: c/o Samsung SDI Co., Ltd.
		428-5, Gongse-dong, Giheung-gu. Yongin-si, Gyeonggi-do, Republic of Korea
Date:	2012/2/1	Signature:
		Name: Han-Seok Yun
		Address: c/o Samsung SDI Co., Ltd.
•		428-5, Gongse-dong, Giheung-gu,
		Yongin-si, Gyeonggi-do, Republic of Korea

PATENT Client Code: SDIYPL.425AUS Page 2

Application No.: Unknown Filing Date: Herewith 0/Cada 2012.2.7 Tersuya Signature: Name: Tetsuya Okada Address: c/o Samsung SDI Co., Ltd. 428-5. Gongse-dong, Giheung-gu, Yongin-si, Gyeonggi-do, Republic of Korea Fores woon Signature: Name: Jong-Woon Yang Address: c/o Samsung SDI Co., Ltd. 428-5, Gongse-dong, Giheung-gu Yongin-si, Gyeonggi-do, Republic of Korea Name: Eui-Jeong Hwang Address: c/o Samsung SDI Co., Ltd 428-5, Gongse-dong, Giheung-gu, Yongin-si, Gyeonggi-do, Republic of Korea

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